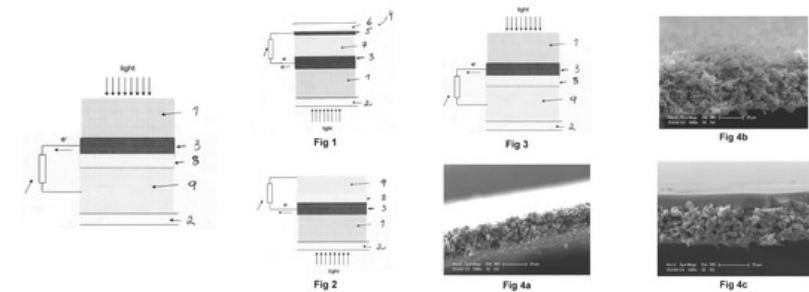
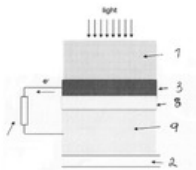


3 results for (Laminar body and nano-particles and TiO2)/TI/AB/IW/CLMS/TX - Collection: FAMPAT

#		Title	Publication number	1st app. date	Applicant/Assignee	1st publ. date	Publ. date
1.		Laminar body for making greenhouse roofs and method of greenhouse cultivation	ITPD20110341	2011-10-31	CYITECH INDUSTRIES Å CYTEC INDUSTRIES* ULTRABATCH	2013-05-01	2013-05-01
The invention relates to, a laminar body for making greenhouse roofs, comprising at least one laminar layer, which defines at least one main surface of the laminar body and comprises a polymer matrix and nano-particles of titanium dioxide TiO2 in the anatase and/or rutilium form, dispersed in the polymer matrix. The nano-particles have dimensions not greater than 100 nm. The titanium dioxide is present with a concentration in weight of between '30 and 1500 ppm in relation to the polymer matrix. The invention also relates to a method of greenhouse cultivation and the use of the laminar body according to the invention for making greenhouse roofs. The invention also relates to a greenhouse having a roof comprising at least one laminar body according to the invention and to a masterbatch for making a laminar layer of a laminar body according to the invention.							
2.		Method for manufacturing dye-sensitized solar cells and solar cells so produced	TW201316540	2012-04-05	AI KESIGE SWEDEN JOINT STOCK EKSEGER SVIDEN EXEGER SWEDEN* NLAB SOLAR	2013-04-16	2013-04-16

A dye-sensitized solar cell having a porous conductive powder layer, which layer is formed by: -deposition of a deposit comprising metal hydride particles onto a substrate; - heating the deposit in a subsequent heating step in order to decompose the metal hydride particles to metal particles; and sinter said metal particles for forming a porous conductive powder layer.



3.		Laminated body used to produce printed wiring board, and method of producing printed wiring board using the same	CN101166393	2006-10-20	FUJIFILM*	2008-04-23	2008-04-23
----	--	--	-------------	------------	---------------------------	------------	------------

The present invention provides a laminated body for producing a printed wiring board, which includes an adhesive layer that is provided between an insulating film for a printed wiring board and a metal film for forming wiring. The adhesive layer includes an active species generating composition that is capable of generating an active species having reactivity by energy application, and a polymer precursor composition that includes a compound capable of forming a polymer compound by reaction with the active species generating composition. The invention also provides a method of producing a printed wiring board.